

INNOLUX DISPLAY CORPORATION

LCD MODULE

SPECIFICATION

Customer: _____

Model Name: CT018TN06 V.1(Linda)

Spec. No.: C018-06-TT-01

Date: 2006/08/25

Version: 1.0

- Preliminary Specification**
- Final Specification**

For Customer's Acceptance

Approved by	Comment

Approved by	Reviewed by	Prepared by
HY Chou	Andy Chou	Lanny Lan

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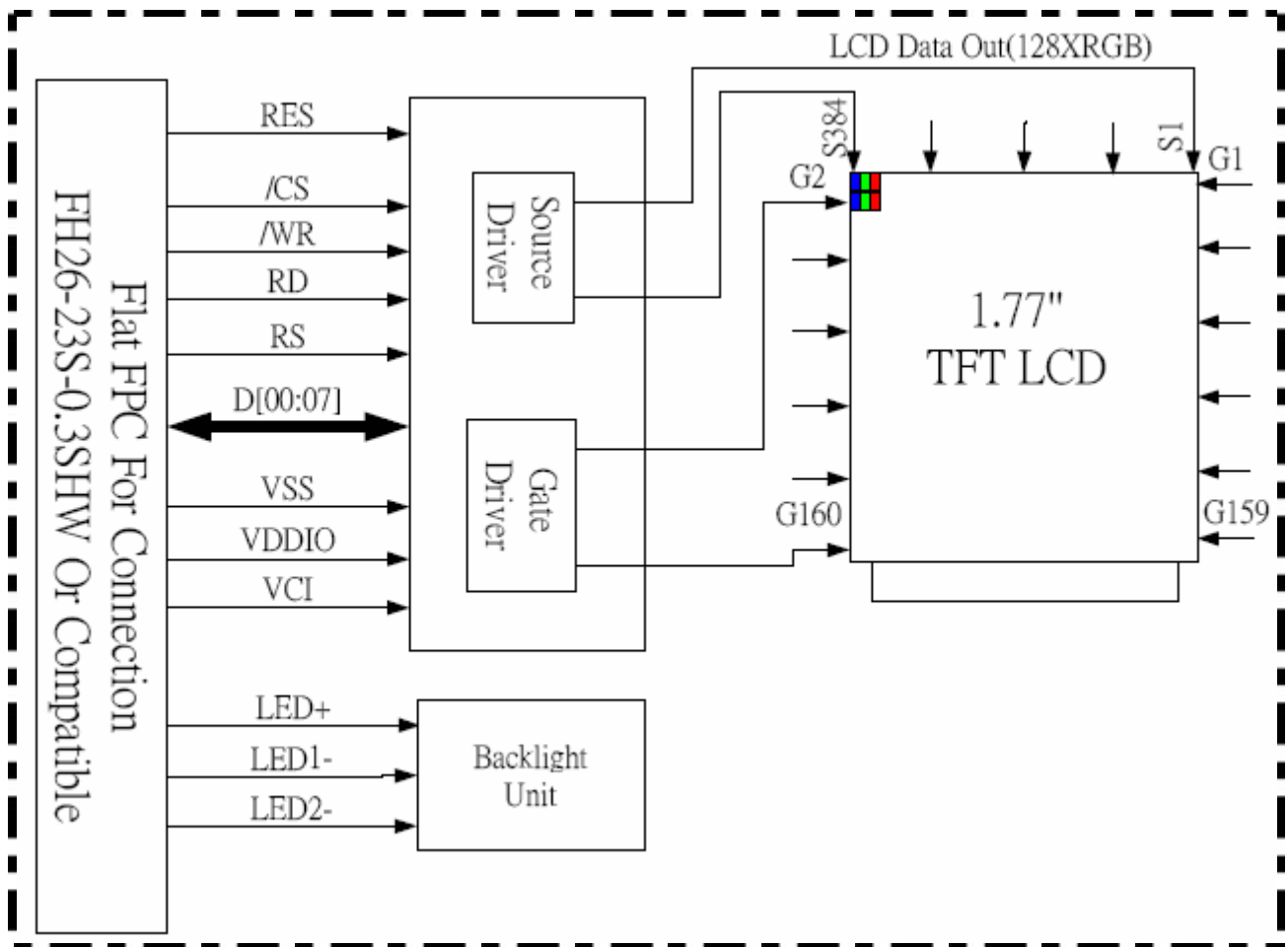
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1. General Specifications

No.	Item	Specification	Unit	Remark
1	LCD Size	1.77	inch	-
2	Panel Type	a-Si TFT active matrix	-	-
3	Resolution	128x (RGB) x 160	pixel	-
4	Display Mode	Normally white, Transmissive	-	-
5	Display Number of Colors	262K/65K	-	-
6	Viewing Direction	12 o'clock	-	Note
7	Contrast Ratio	250(Typ)	-	-
8	Luminance	240(Typ)	cd/m ²	-
9	Module Size	34.00(W) x 47.00(L)x2.60(T)	mm	Note
10	Active Area	28.032(W) x 35.04(L)	mm	Note
11	Pixel Pitch	0.219(W) x 0.219(L)	mm	-
12	Weight	TBD	g	-
13	Driver IC	S6D0144	-	-
14	Driver IC RAM Size	128x18x160	bit	-
15	Light Source	2 LEDs White	-	-
16	Interface	8080 system 8-bit Parallel	-	-
17	Operating Temperature	-10~60		-
18	Storage Temperature	-20~70		-

Note: Please refer to the mechanical drawing on Page 16.

2. Block Diagram



3. Pin Assignments

Pin No.	Symbol	I/O	Function	Remark
1	VSS	P	Ground	-
2	VSS	P	Ground	-
3	VSS	P	Ground	-
4	RD	I	Read data signal (Low: active)	-
5	D07	I/O	Data bus (Bit 07)	-
6	LED+	-	LED Common Anode	-
7	D06	I/O	Data bus (Bit 06)	-
8	LED1-	-	LED Cathode	-
9	D05	I/O	Data bus (Bit 05)	-
10	LED2-	-	LED Cathode	-
11	D04	I/O	Data bus (Bit 04)	-
12	VDDIO	P	I/O Supply Voltage	-
13	D03	I/O	Data bus (Bit 03)	-
14	VCI	P	Analog supply voltage	-
15	D02	I/O	Data bus (Bit 02)	-
16	VCI	P	Analog supply voltage	-
17	D01	I/O	Data bus (Bit 01)	-
18	/CS	I	Chip select (Low: active)	-
19	D00	I/O	Data bus (Bit 00)	-
20	RS	I	Register select	-
21	/WR	I	Write data signal	-
22	RES	I	Reset signal	-
23	VSS	P	GND	-

4. Electrical Specifications

4.1 Absolute Maximum Rating

($T_a=+25$)

Item	Symbol	Values		Unit	Remark	
		Min.	Max.			
TFT Module	I/O Supply Voltage	VDDIO	-0.3	+5.0	V	Note 1
	Analog Supply Voltage	VCI	-0.3	+5.0	V	Note 1
Backlight Unit	Current	I_B	-	50	mA	Note 2
	Power Consumption	P_{BL}	-	160	mW	Note 2

Note1: Permanent damage to the device may occur if maximum values are exceeded or reverse voltage is applied.

Note2: Without LED driver IC, please refer to 4.3

4.2 Typical Operation Conditions

($T_a=+25$, $V_{CI}=+2.8V$ $V_{DDIO}=+2.8V$)

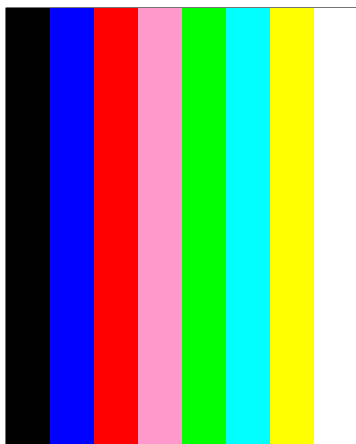
Item	Symbol	Values			Unit	Remark	
		Min.	Typ.	Max.			
Logic Supply Voltage	VDDIO	1.65	2.8	3.3	V	-	
Analog Supply Voltage	VCI	2.5	2.8	3.3	V	-	
Input High Voltage	V _{IH}	0.7 VDDIO	-	VDDIO	V	Note1	
Input Low Voltage	V _{IL}	0V		0.3VDDIO	V	Note1	
Current Consumption	Standby	I _{STB}	-	10	20	μA	Note2
	Still	I _{STILL}	-	1.4	2.0	mA	Note3
Frame Frequency	f _{FRAME}	-	60	-	Hz	-	

Note1: To prevent IC latch up or DC operation in LCD panel, the power on/off sequence should follow the driver IC specification.

Note2: In the Standby mode, all the internal display operations are suspended including the internal R-C oscillator.

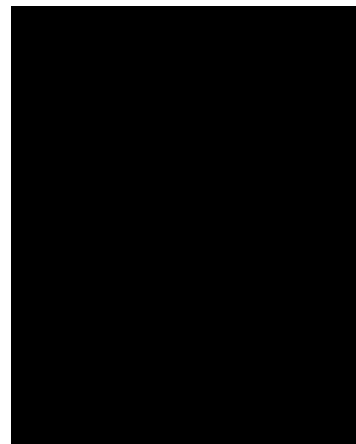
Note3: Test patterns:

Typ. current check pattern:



8-Color Bar

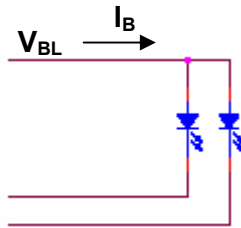
Max. current check pattern:



Black

4.3 Backlight Unit

The backlight system is an edge lighting type with 2 white LEDs.



($T_a = +25$)

Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Current	I_B	-	36	-	mA	Note 1
Power Consumption	P_{BL}	-	115	-	mW	Note 2

Note1: 2 LEDs are connected in parallel; each LED forward current is 18mA.

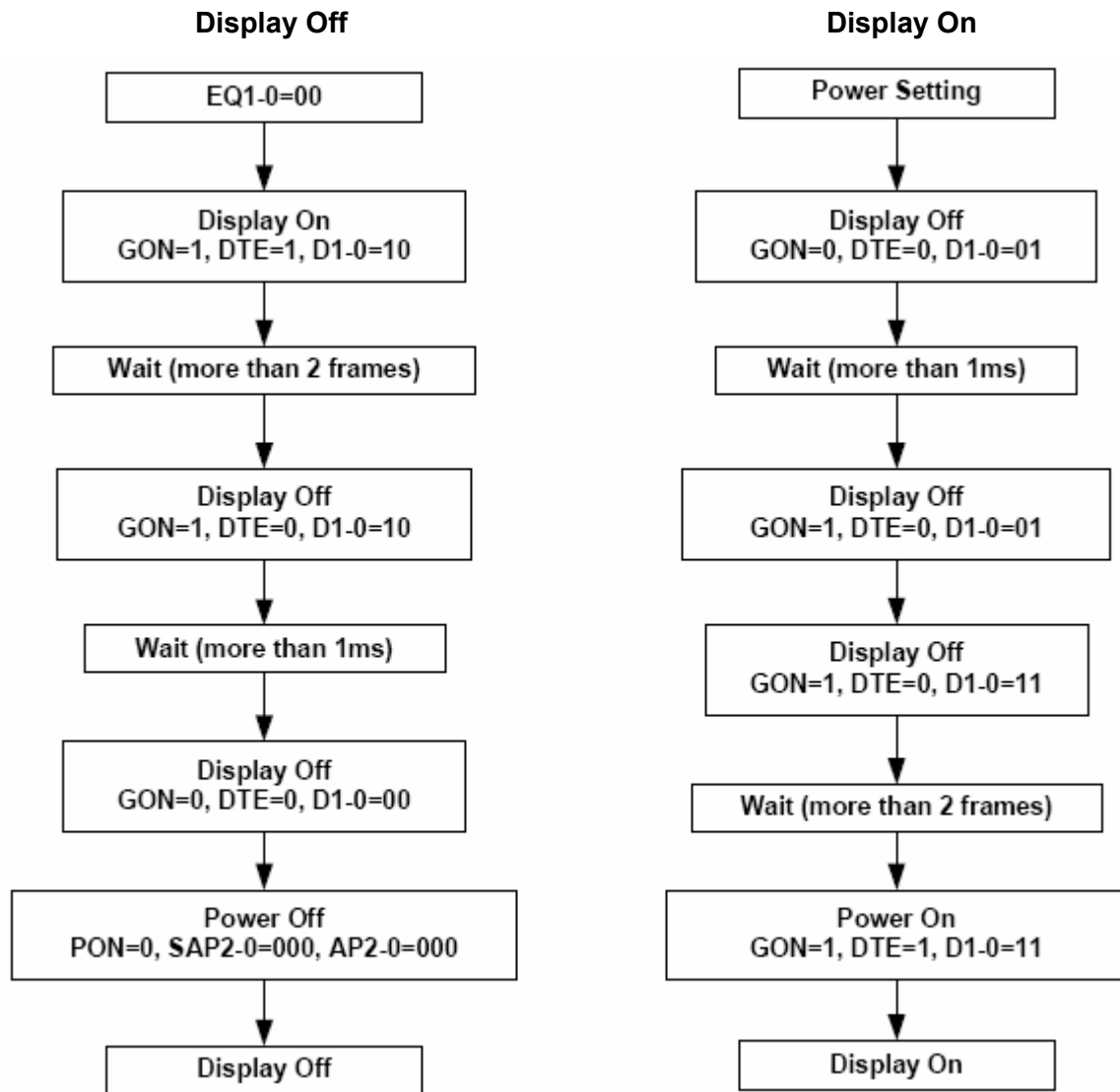
Note2: Where $I_B = 36\text{mA}$, $P_{BL} = I_B \times V_{BL}$

4.4 Instruction List

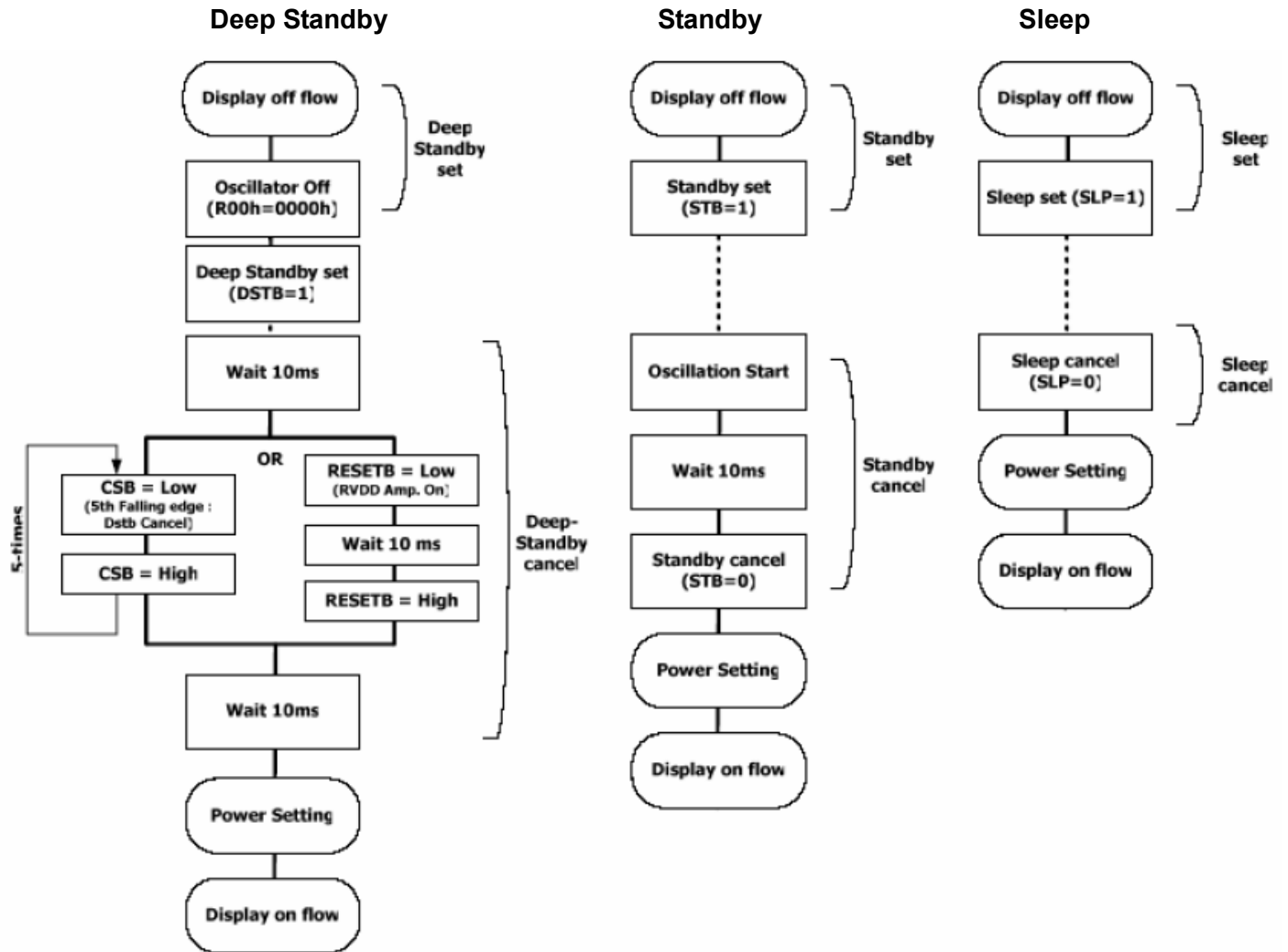
TBD

4.5 Instruction Setting Flow

4.5.1 Display On/Off Sequence

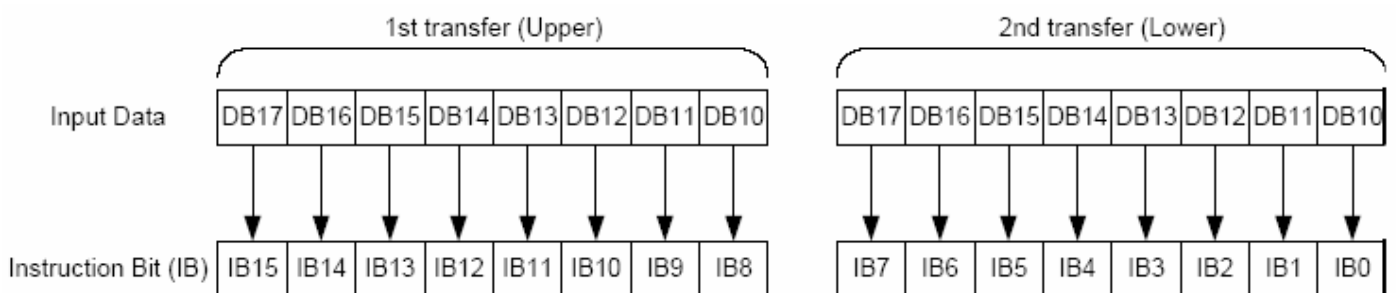


4.5.2 Deep Standby, Standby & Sleep Mode Sequence

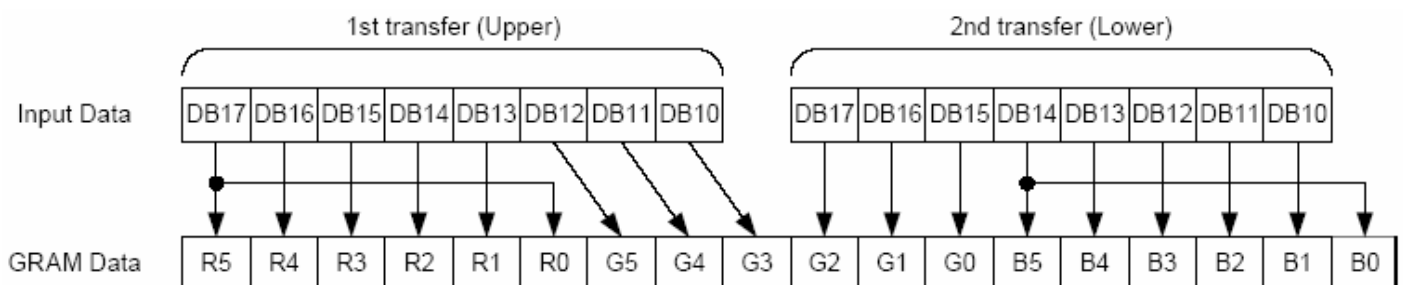


4.6 Display RAM Data Format and input Bus

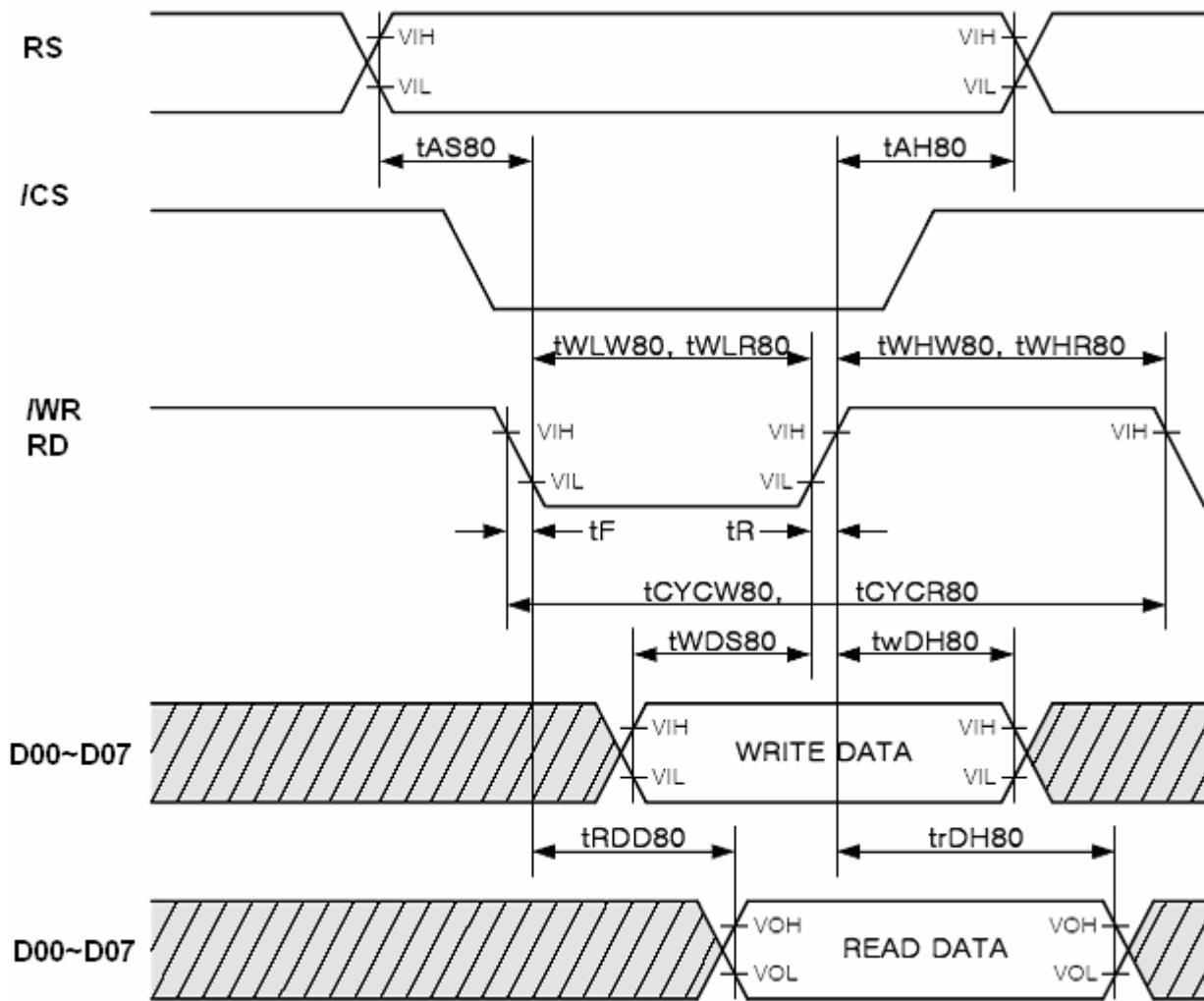
4.6.1 Bit Assignment of Instructions on 8080 8-Bit CPU Interface



4.6.2 Bit Assignment of GRAM Data on 8080 8-Bit CPU Interface (65,536 Color)



4.7 Timing Characteristic



Paraeter	Description	Min	Max	Unit
tCYCW80	Cycle time (Write)	100	-	ns
tCYCR80	Cycle time (Read)	500	-	
tR, tF	Pulse rise/fall time	-	25	
tWLW80	Pulse Width Low (Write)	40	-	
tWLR80	Pulse Width Low (Read)	250	-	
tWHW80	Pulse Width High (Write)	40	-	
tWHR80	Pulse Width High (Read)	200	-	
tAS80	RS to /CS, /WR (or RD) setup time	0	-	
tAH80	RS to /CS, /WR (or RD) hold time	0	-	
tWDS80	Write data setup time	60	-	
tWDH80	Write data hold time	2	-	
tRDD80	Read data delay time	-	200	
tRDH80	Read data hold time	5	-	

5. Optical Specifications

($T_a=+25$, $V_{DDIO}=+2.8V$ $V_{CI}=+2.8V$, $I_B=36mA$)

Item	Symbol	Condition	Values			Unit	Remark	
			Min.	Typ.	Max.			
Viewing Angle Range	Left	θ_L	CR 10	-	45	-	degree	Note 1,2
	Right	θ_R		-	45	-		
	Top	θ_T		-	35	-		
	Bottom	θ_B		-	15	-		
Response Time	$T_{on} + T_{off}$	Normal $\theta=\phi=0^\circ$	-	30	50	ms	Note 2,3	
Contrast Ratio	CR	Normal $\theta=\phi=0^\circ$	200	250	-	-	Note 2,4	
Luminance	L	Normal $\theta=\phi=0^\circ$	-	240	-	cd/m ²	Note 2,5	
Color Chromaticity (CIE1931)	White	W_x	Normal $\theta=\phi=0^\circ$	0.260	0.310	0.360	-	Note 2,6
		W_y		0.280	0.330	0.380		
	Red	R_x		0.611	0.641	0.671		
		R_y		0.315	0.345	0.375		
	Green	G_x		0.266	0.296	0.326		
		G_y		0.554	0.584	0.614		
	Blue	B_x		0.102	0.132	0.162		
		B_y		0.106	0.136	0.166		
Color Gamut	NTSC	CIE1931	-	58	-	%	-	
Luminance Uniformity	U_L	Normal $\theta=\phi=0^\circ$	75	80	-	%	Note 2,7	

Note 1: Definition of viewing angle range

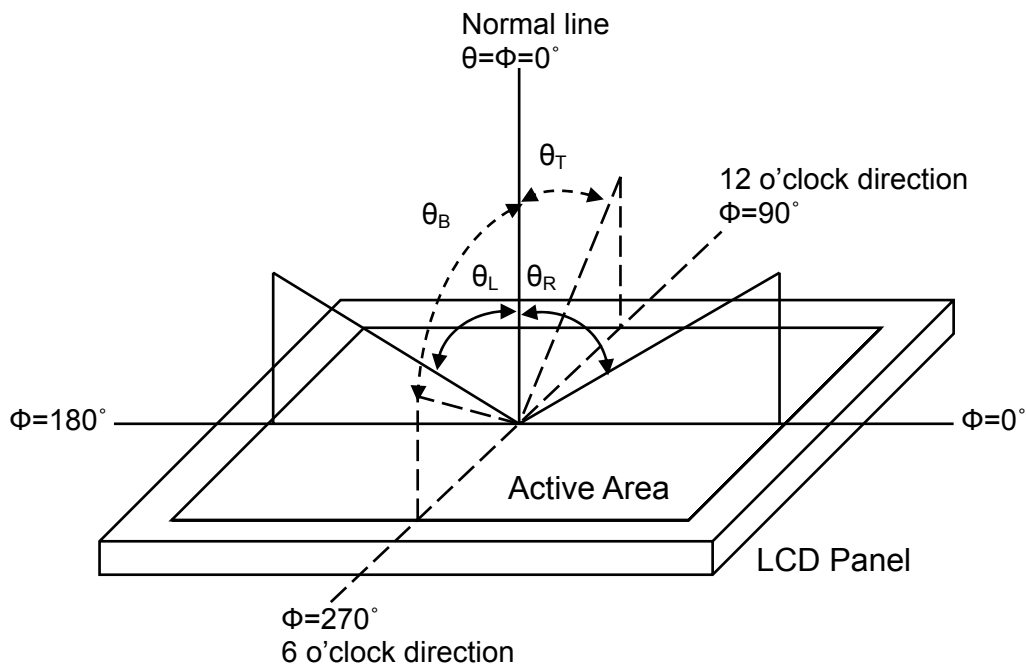


Fig. 1 Definition of viewing angle

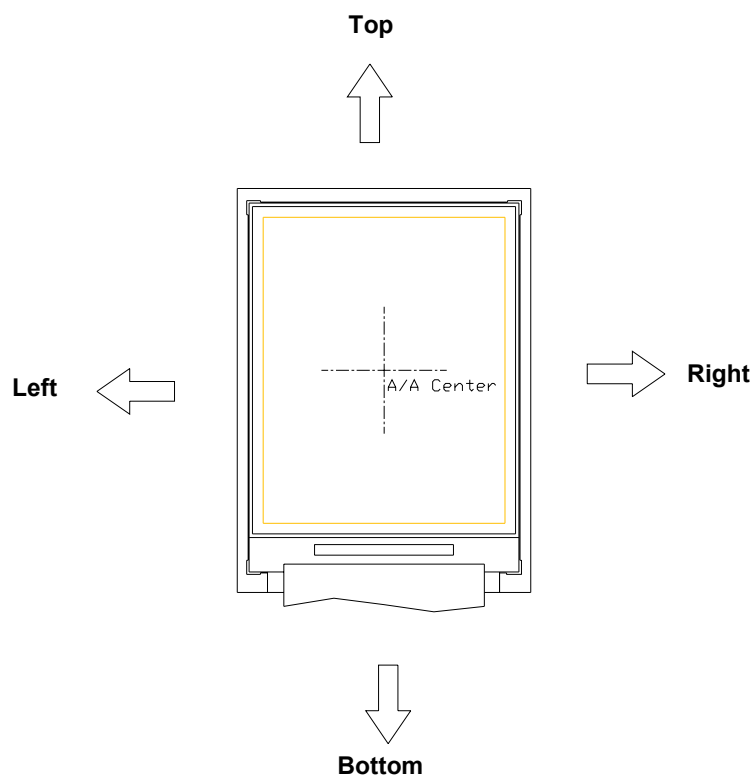


Fig. 2 Definition of viewing angle for display

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Note 2: Definition of optical measurement system

The optical characteristics should be measured in a dark room with ambient temperature $T_a=+25$. The optical properties are measured at the center point of the LCD screen after 5 minutes operation. (Equipment: Photo detector TOPCON BM-5A or BM-7 /Field of view: 1° /Height: 500mm.)

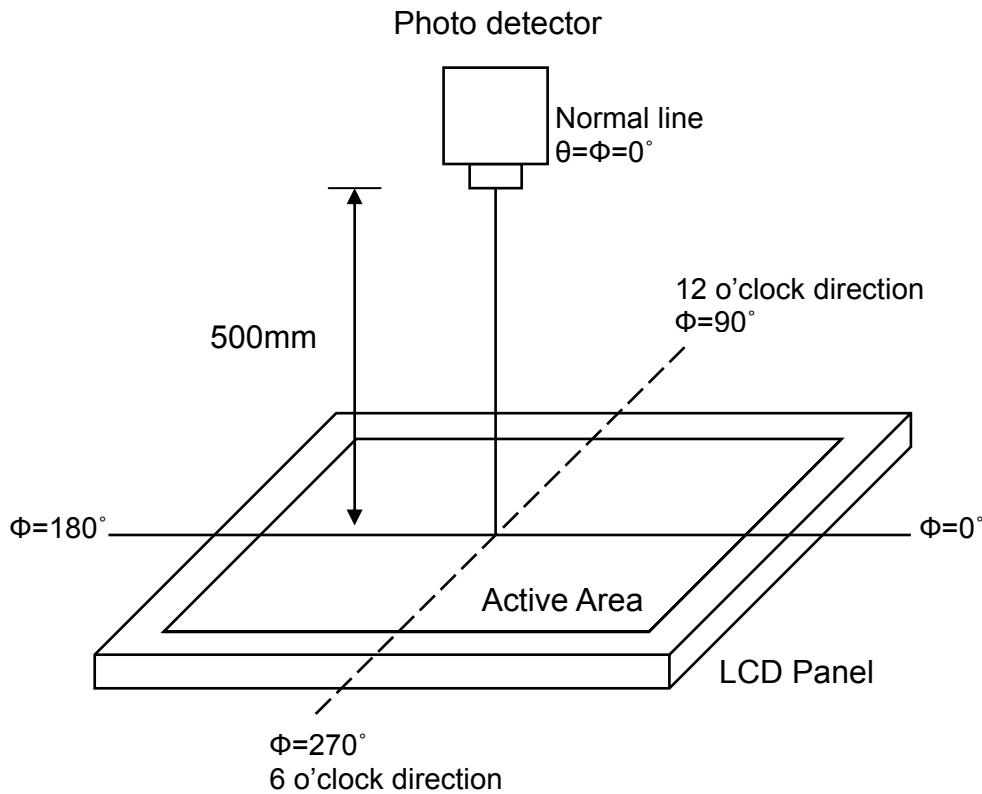


Fig. 3 Optical measurement system setup

Note 3: Definition of response time

The response time is defined as the LCD optical switching time interval between “White” state and “Black” state. Rise time (T_{on}) is the time between photo detector output intensity changed from 90% to 10%, and fall time (T_{off}) is the time between photo detector output intensity changed from 10% to 90%.

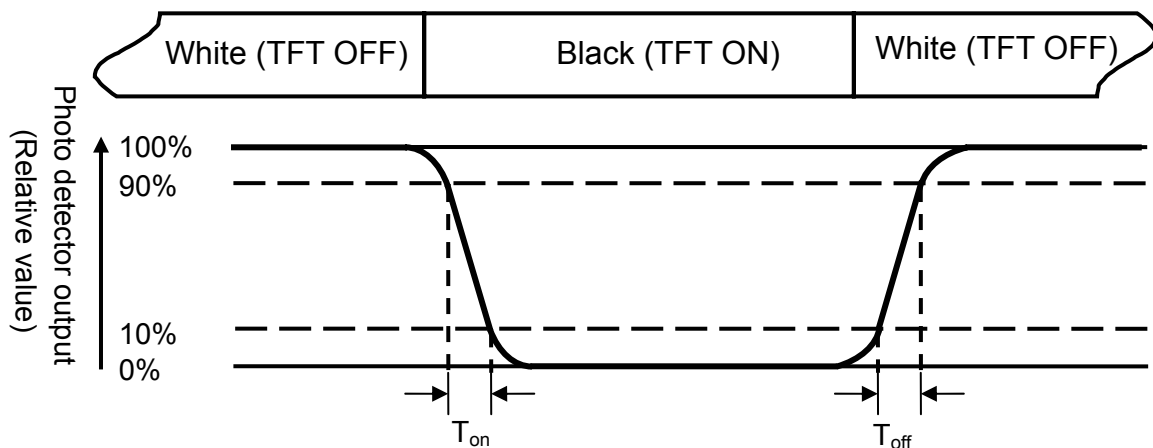


Fig. 4 Definition of response time

Note 4: Definition of contrast ratio

$$\text{Contrast ratio (CR)} = \frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$$

Note 5: Definition of luminance

Measured at the center area of the panel when LCD panel is driven at "white" state.

Note 6: Definition of color chromaticity (CIE1931)

Color coordinates measured at the center point of LCD when panel is driven at "White", "Red", "Green" and "Blue" state respectively.

Note 7: Definition of luminance uniformity

To test for uniformity, the tested area is divided into 3 rows and 3 columns. The measurement spot is placed at the center of each circle as below.

$$\text{Luminance Uniformity (U}_L) = \frac{L_{\min}}{L_{\max}}$$

L-----Active area length

W----- Active area width

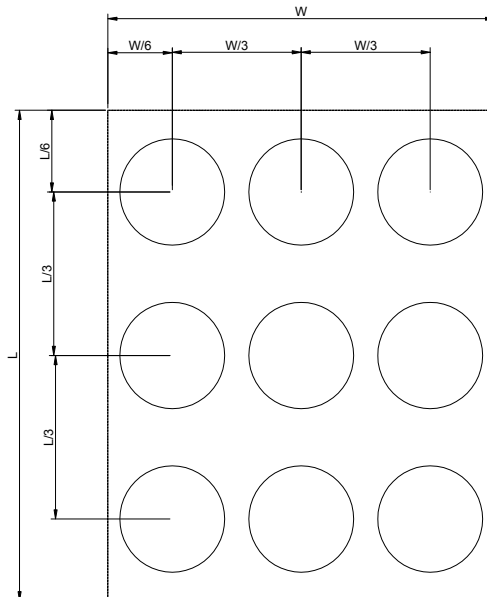


Fig. 5 Definition of luminance uniformity

L_{\max} : The measured maximum luminance of all measurement position.

L_{\min} : The measured minimum luminance of all measurement position.

6. Reliability Test Items

Test Items	Test Conditions	Remark
High Temperature Storage	+80 ±3 for 240 hours	-
Low Temperature Storage	-30 ±3 for 240 hours	-
High Temperature Operation	+70 ±3 for 240 hours	-
Low Temperature Operation	-20 ±3 for 240 hours	-
High Temperature and Humidity Operation	+60 ±3 , 90%±3%RH max. for 240 hours	-
Thermal Shock	-30 /0.5h ~ +80 /0.5h for a total 100 cycles, Start with cold temp and end with high temp	-
Vibration Test	Frequency range:10~55Hz Stoke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X. Y. Z. (6 hours for total)	-
Mechanical Shock	100G 6ms,±X, ±Y, ±Z 3 times for each direction	-
Package Vibration Test	Random Vibration : 0.015G ² /Hz from 5-200Hz, -6dB/Octave from 200-500Hz 1 hour for each direction of X. Y. Z. (3 hours for total)	-
Package Drop Test	Height :72cm(Weight 10kg); 60cm(Weight>10kg) 1 corner, 3 edges, 6 surfaces	-
Electro Static Discharge	± 2KV, Human Body Mode, 100pF/1500Ω	-

Note1: During the display practical test under normal operation condition, there shall be not change or effect to the display function.

Note2: Before function check, the test sample requires 2 hours storage at room temperature.

7. Handling Precautions

7.1 Safety

- 7.1.1 The liquid crystal in the LCD is poisonous. **DO NOT** put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.

7.2 Handling

- 7.2.1 The LCD panel is made of plate glass. **DO NOT** subject the panel to mechanical shock or to excessive force on its surface.
- 7.2.2 The polarizer attached to the display is easily to be damaged, please handle it with care.
- 7.2.3 To avoid contamination on the display surface, **DO NOT** touch the display surface with bare hands.
- 7.2.4 Provide a space so that the LCD panel does not come into contact with other components.
- 7.2.5 To protect the LCD panel from external force, put a covering lens (acrylic board or similar board) and keep an appropriate gap between them.
- 7.2.6 Transparent electrodes may be disconnected if the LCD panel is used under environmental conditions where dew condensation occurs.
- 7.2.7 Property of semiconductor devices may be affected when they are exposed to light, possibly resulting in IC malfunctions.
- 7.2.8 To prevent such IC malfunctions, your design and mounting layout shall be done in the way that the IC is not exposed to light in actual use.

7.3 Static Electricity

- 7.3.1 Ground soldering iron tips, tools and testers when they are in operation.
- 7.3.2 Ground your body when handling the products.
- 7.3.3 Power on the LCD module **BEFORE** applying the voltage to the input terminals.
- 7.3.4 **DO NOT** apply voltage which exceeds the absolute maximum rating.
- 7.3.5 Store the products in an anti-electrostatic bag or container.

7.4 Storage

- 7.4.1 Store the products in a dark place at +25 ±10 with low humidity (65%RH or less).
- 7.4.2 **DO NOT** store the products in an atmosphere containing organic solvents or corrosive gas.

7.5 Cleaning

- 7.5.1 **DO NOT** wipe the polarizer with dry cloth, as it may cause scratch.
- 7.5.2 Wipe the polarizer with a soft cloth soaked with petroleum IPA, other chemical may damage the product.

8. Mechanical Drawing

